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The applicant and/or attorney requests the date of deposit as the filing date. Depositor: KAREN CINQ-MARS

Karen Cinq-Mars 7/11/03
(Signature & date)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : 7/11/03
Peter Berasi, et al. : Group Art Unit:

Serial No. 10/604,213 : Examiner:

Filed: 7/01/03 International Business
Machines Corporation
2070 Route 52
Hopewell Junction, NY 12533

TITLE: MOLY MASK CONSTRUCTION AND PROCESS

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

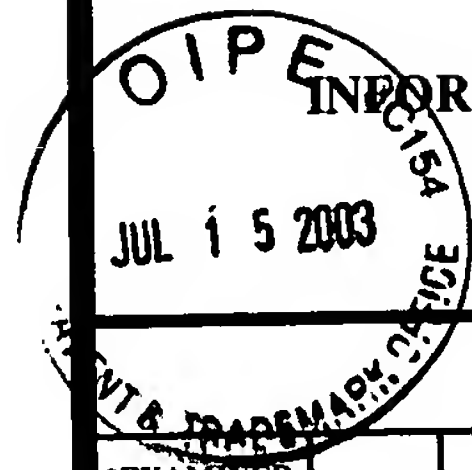
Sir:

Pursuant to the duty of disclosure set forth in 37 C.F.R. 1.56, and further pursuant to the provisions of 37 C.F.R. 1.97 and 1.98, applicants hereby respectfully submit copies of the prior patents and publications as listed on Form PTO-1449, attached hereto.

In citing these documents, no representation is made nor intended as to the pertinency or non-pertinency of the art, that better art than that listed is not available, or that other art is not applicable.

Respectfully submitted,
Peter Berasi, et al.

By James J. Cioffi 7/9/03
James J. Cioffi, Attorney
Registration No. 51,564
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INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

Docket Number (Optional)

FIS920030099US1

Application Number

Applicant(s)

PETER BERASI, ET AL.

Filing Date

7/01/03

Group Art Unit

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

FOREIGN PATENT DOCUMENTS

REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

FIS919990286US1-SERIAL NO. 09/596,754 (has been abandoned)

Technical Report:"ESSONNES TIN CAP PROCESS DEVELOPMENT SUMMARY" NOV.24, 1994, 95A001149
Technical Report:"TEMPORY CHIP ATTACH TECHNIQUE FOR BURN IN OF CMOS CHIPS WITH TIN CAP PADS",

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.